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Dated: January 28, 2003

Signature: 
(Marcus J. Millet)

Docket No.: TESSERA 3.0-102 II DIV
(PATENT)

2827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Thomas H. DiStefano

Serial No.: 09/628,049

Group Art Unit: 2827

Filed: July 27, 2000

Examiner: D. Graybill

For: PACKAGED MICROELECTRONIC
ELEMENTS WITH ENHANCED THERMAL
CONDUCTION

LETTER TO OFFICIAL DRAFTSMAN

Commissioner for Patents
Washington, DC 20231


Dear Sir:

Subject to approval of the Examiner, please substitute the seven (7) sheets of formal drawings enclosed herewith for the informal drawings presently on file. The formal drawings further respond to the objections set forth in the Official Action mailed August 28, 2002 by incorporating the changes set forth in applicant's Amendment dated December 30, 2002, filed in response to said Official Action.

In the event there are any fees due or owing in connection with this matter, please charge same to our Deposit Account No. 12-1095.

Dated: January 28, 2003

Respectfully submitted,

By 
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